

DSC6001HI2A-006.1400 Datasheet

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DiGi Electronics Part Number	DSC6001HI2A-006.1400-DG
Manufacturer	Microchip Technology
Manufacturer Product Number	DSC6001HI2A-006.1400
Description	MEMS OSC XO 6.1400MHZ CMOS SMD
Detailed Description	6.14 MHz XO (Standard) CMOS Oscillator 1.71V ~ 3. 63V Standby (Power Down) 4-VEI GA

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Purchase and inquiry

Manufacturer Product Number:Manufacturer Product Number:DSC6001HI2A-006.1400Microchip TechnologySeries:Packaging:DSC60XXBagPart Status:Base Resonator:ObsoleteMEMSType:Frequency:XO (Standard)6.14 MHzFunction:Output:Standby (Power Down)CMOSVoltage - Supply:Frequency Stability:1.71V - 3.63V225pmAbsolute Pull Range (APR):Operating Temperature:Stread Spectrum Bandwidth:Current - Supply (Max):Attings:Mounting Type:Attings:Surface MountAcc-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGAOu5* Lx 0.047" W (1.60mm x 1.20mm)Height - Seated (Max):Current - Supply (Max):		
Series:Packaging:DSC60XXBagPart Status:Base Resonator:ObsoleteBase Resonator:ObsoleteMEMSType:Frequency:XO (Standard)6.14 MHzFunction:Output:Standby (Power Down)CMOSVoltage - Supply:Frequency Stability:1.71V ~ 3.63V425pmAbsolute Pull Range (APR):Operating Temperature:40°C ~ 85°CSpread Spectrum Bandwidth:Current - Supply (Max):-1.3mA (Typ)Ratings:Mounting Type:AEC-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGAOtost" k 0.063" k x 0.047" W (1.60mm x 1.20mm)	Manufacturer Product Number:	Manufacturer:
DSC60XXBagPart Status:Base Resonator:ObsoleteMEMSType:Frequency:Type:6.14 MHzX0 (Standard)Output:Function:Output:Standby (Power Down)CMOSVoltage - Supply:Frequency Stability:1.71V ~ 3.63VPoerting Temperature:Absolute Pull Range (APR):Outputs:40°C ~ 85°CSpread Spectrum Bandwidth:Current - Supply (Max):-1.3mA (Typ)Ratings:Mounting Type:AEC-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGAOc3" L x 0.047" W (1.60mm x 1.20mm)	DSC6001HI2A-006.1400	Microchip Technology
Part Status:Base Resonator:ObsoleteMEMSType:Frequency:X0 (Standard)6.14 MHzFunction:Output:Standby (Power Down)CMOSVoltage - Supply:Frequency Stability:1.71V ~ 3.63V±25ppmAbsolute Pull Range (APR):Operating Temperature:40°C ~ 85°CSpread Spectrum Bandwidth:Current - Supply (Max):-1.3mA (Typ)Ratings:Mounting Type:AEC-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGAOle3" L x 0.047" W (1.60mm x 1.20mm)	Series:	Packaging:
ObsoleteMEMSType:Frequency:X0 (Standard)6.14 MHzFunction:Output:Standby (Power Down)CMOSVoltage - Supply:Frequency Stability:1.71V ~ 3.63V-25ppmAbsolute Pull Range (APR):Operating Temperature:40°C ~ 85°CSpread Spectrum Bandwidth:Current - Supply (Max):-1.3mA (Typ)Ratings:Mounting Type:AEC-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGAOcia" t x .047" W (1.60mm x 1.20mm)	DSC60XX	Bag
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Standby (Power Down)CMOSVoltage - Supply:Frequency Stability:1.71V ~ 3.63V±25ppmAbsolute Pull Range (APR):Operating Temperature:40°C ~ 85°CSpread Spectrum Bandwidth:Current - Supply (Max):-1.3mA (Typ)Ratings:Mounting Type:AEC-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGANoder Will L60mm x 1.20mm)	XO (Standard)	6.14 MHz
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AEC-Q100Surface MountPackage / Case:Size / Dimension:4-VFLGA0.063" L x 0.047" W (1.60mm x 1.20mm)		1.3mA (Typ)
Package / Case: Size / Dimension: 4-VFLGA 0.063" L x 0.047" W (1.60mm x 1.20mm)	Ratings:	Mounting Type:
4-VFLGA 0.063" L x 0.047" W (1.60mm x 1.20mm)	AEC-Q100	Surface Mount
	Package / Case:	Size / Dimension:
Height - Seated (Max): Current - Supply (Disable) (Max):	4-VFLGA	0.063" L x 0.047" W (1.60mm x 1.20mm)
	Height - Seated (Max):	Current - Supply (Disable) (Max):
0.035" (0.89mm) -	0.035" (0.89mm)	-

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0060	



Ultra-Small, Ultra-Low Power MEMS Oscillator

Features

- Wide Frequency Range: 2 kHz to 80 MHz
- Ultra-Low Power Consumption: 1.3 mA/12 μA (Active/Standby)
- Ultra-Small Footprints
 - 1.6 mm × 1.2 mm
 - 2.0 mm × 1.6 mm
 - 2.5 mm × 2.0 mm
 - 3.2 mm × 2.5 mm
- Frequency Select Input Supports Two Pre-Defined Frequencies
- High Stability: ±25 ppm, ±50 ppm
- Wide Temperature Range
 - Industrial: -40°C to 85°C
 - Ext. Commercial: -20° to 70°C
- Excellent Shock and Vibration Immunity
 - Qualified to MIL-STD-883
- · High Reliability
 - 20x Better MTF Than Quartz Oscillators
- Supply Range of 1.71V to 3.63V
- Short Sample Lead Time: <2 weeks
- Lead Free & RoHS Compliant

Applications

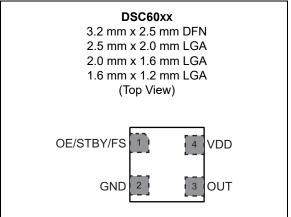
- Low Power/Portable Applications: IoT, Embedded/Smart Devices
- Consumer: Home Healthcare, Fitness Devices, Home Automation
- Automotive: Rear View/Surround View Cameras, Infotainment System
- Industrial: Building/Factory Automation, Surveillance Camera

General Description

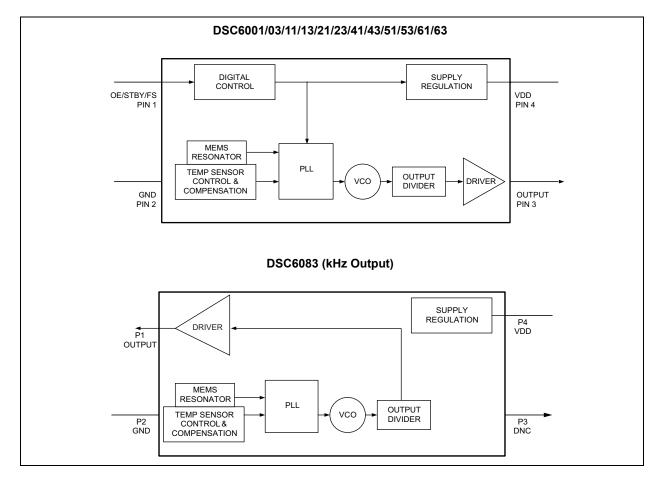
The DSC60xx family of MEMS oscillators combines industry-leading low-power consumption, ultra-small packages with exceptional frequency stability, and jitter performance over temperature. The single-output DSC60xx MEMS oscillators are excellent choices for use as clock references in small, battery-powered devices such as wearable and Internet of Things (IoT) devices in which small size, low power consumption, and long-term reliability are paramount. They also meet the stringent mechanical durability and reliability requirements within Automotive Electronics Council standard Q100 (AEC-Q100), so they are well suited for under-hood applications as well.

The DSC60xx family is available in ultra-small 1.6 mm x 1.2 mm and 2.0 mm x 1.6 mm packages. Other package sizes include: 2.5 mm x 2.0 mm and 3.2 mm x 2.5 mm. These packages are "drop-in" replacements for standard 4-pin CMOS quartz crystal oscillators.

Package Types



Block Diagrams



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Supply Voltage	
Input Voltage (V _{IN})	
ESD Protection	

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: Unless otherwise indicated, V_{DD} = 1.8V –5% to 3.3V +10%, T_A = –40°C to 85°C.									
Parameters	eters Symbol Min. Typ. Max. Units Conditions					Conditions			
Supply Voltage Note 1	V _{DD}	1.71		3.63	V	—			
		_	1.3	_		F _{OUT} = 24 MHz, V _{DD} = 1.8V, No Load			
Active Supply Current	I _{DD}	_	1.19	_	mA	F _{OUT} = 32.768 kHz (DSC6083), V _{DD} = 1.8V, No Load			
Power Supply Ramp	t _{PU}	0.1		100	ms	Note 9			
Standby Supply Current	lozov	_	12	—		V _{DD} = 1.8/2.5V			
Note 2	I _{STBY}	_	80	—	μA	V _{DD} = 3.3V			
Frequency Stability Note 3	Δf	—	_	±25 ±50	ppm	All temp ranges			
Aging	Δf	_		±5	0000	1st year @25°C			
Aging				±1	ppm	Per year after first year			
Startup Time	t _{SU}	_		1.3	ms	From 90% V _{DD} to valid clock output, T = 25°C			
Innut Logic Lougle Note 4	V _{IH}	0.7 x V _{DD}	_	_	V	Input Logic High			
Input Logic Levels Note 4	V _{IL}	_		0.3 x V _{DD}	V	Input Logic Low			
Output Disable Time Note 5	t _{DA}	—	_	200+Period	μs	—			
Output Enable Time Note 6	t _{EN}	_	_	1	μs	_			
Enable Pull-Up Resistor Note 7	_	_	300	_	kΩ	If configured			
Output Logic Levels,	V _{OH}	$0.8 \times V_{DD}$	_	_	V	Output Logic High, I = 1 mA			
Low Drive	V _{OL}	_	_	0.2 x V _{DD}	V	Output Logic Low, I = –1 mA			

Note 1: Pin 4 V_{DD} should be filtered with 0.1 μ F capacitor.

2: Not including current through pull-up resistor on EN pin (if configured). Higher standby current seen at >3.3V V_{DD} .

- **3:** Includes frequency variations due to initial tolerance, temp. and power supply voltage.
- 4: Input waveform must be monotonic with rise/fall time < 10 ms
- 5: Output Disable time takes up to one period of the output waveform + 200 ns.
- 6: For parts configured with OE, not Standby.
- 7: Output is enabled if pad is floated or not connected.
- 8: Output Duty Cycle will be 40% to 60% when output frequency is between 40 MHz to 60 MHz.
- 9: Time to reach 90% of target $V_{\mbox{\scriptsize DD}}.$ Power ramp rise must be monotonic.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions		
		—	2.5	3.5		DSC60x3 Low Drive, 20% to 80% C _L = 5 pF	V _{DD} = 1.8V	
Output Transition Time	t _{RX} /t _{FX}	_	1.5	2.2	— ns		V _{DD} = 2.5V/3.3V	
Rise Time/Fall Time	+ /+	_	1.2	2.0	— ns	DSC60x1 Std. Drive,	V _{DD} = 1.8V	
	t _{RY} /t _{FY}	—	0.6	1.2	115	20% to 80% C _L = 10 pF	V _{DD} = 2.5V/3.3V	
Frequency	f ₀	0.002	—	80	MHz	Output on Pin	1 for < 1 MHz	
Output Duty Cycle, Note 8	SYM	45	—	55	%	_		
	J _{PER}	_	32	40		$\begin{array}{c} \text{DSC60x3}\\ \text{Low Drive,}\\ \text{F}_{\text{OUT}} = \\ 27 \text{ MHz} \end{array}$ s_{RMS} DSC60x1 Std. Drive, F_{\text{OUT}} = \\ 27 \text{ MHz} \end{array}	V _{DD} = 1.8V	
Period Jitter, RMS		_	25	32			V _{DD} = 2.5V/3.3V	
renou siller, Nivis		_	23	30	PSRMS		V _{DD} = 1.8V	
		—	20	28			V _{DD} = 2.5V/3.3V	
	J _{Cy–Cy}	—	180	240		DSC60x3 Low Drive, F _{OUT} = 27 MHz	V _{DD} = 1.8V	
Cycle-to-Cycle Jitter		_	120	170			V _{DD} = 2.5V/3.3V	
(peak)		_	115	190	— ps	DSC60x1, Std. Drive,	V _{DD} = 1.8V	
		_	90	150		F _{OUT} = 27 MHz	V _{DD} = 2.5V/3.3V	

Note 1: Pin 4 V_{DD} should be filtered with 0.1 µF capacitor.

- 2: Not including current through pull-up resistor on EN pin (if configured). Higher standby current seen at >3.3V V_{DD} .
- **3:** Includes frequency variations due to initial tolerance, temp. and power supply voltage.
- 4: Input waveform must be monotonic with rise/fall time < 10 ms
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- 6: For parts configured with OE, not Standby.
- 7: Output is enabled if pad is floated or not connected.
- 8: Output Duty Cycle will be 40% to 60% when output frequency is between 40 MHz to 60 MHz.
- 9: Time to reach 90% of target V_{DD}. Power ramp rise must be monotonic.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Maximum Junction Temperature	TJ		_	+150	°C	—
Ambient Operating Temperature	Τ _Α	-40	—	+85	°C	Industrial
Ambient Operating Temperature	Τ _Α	-20	_	+70	°C	Extended Commercial
Storage Ambient Temperature Range	Τ _Α	-55	_	+150	°C	—
Soldering Temperature	Τ _S	_	+260		°C	40 sec. max.

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +150°C rating. Sustained junction temperatures above +150°C can impact the device reliability.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1 and Table 2-2.

TABLE 2-1: DSC6001/03/11/13/21/23/41/43/51/53/61/63 PIN FUNCTION TABLE (OUTPUT ≥1 MHZ)

Pin Number	Pin Name	Pin Type	Description		
	OE		Output Enable: H = Specified Frequency Output, Note 1 L = Output is high impedance		
1	STBY	I	Standby: H = Specified Frequency Output, Note 1 L = Output is high impedance, Device is in low power mode, Supply current is at I _{STBY}		
	FS	Frequency Select: H = Output Frequency 1, Note 2 L = Output Frequency 2			
2	GND	Power	Power supply ground		
3	Output	0	Oscillator clock output		
4	VDD	Power	Power supply, Note 3		

Note 1: DSC600x/1x/2x has 300 kΩ internal pull-up resistor on pin1. DSC604x/5x/6x has no internal pull-up resistor on pin1 and needs an external pull-up or to be driven by another chip.

2: Two pre-programmed frequencies can be configured at http://clockworks.microchip.com/timing/.

3: Bypass with 0.1 µF capacitor placed as close to the V_{DD} pin as possible.

TABLE 2-2: DSC6083 PIN FUNCTION TABLE (OUTPUT FREQUENCY <1 MHZ)

Pin Number	Pin Name	Pin Type	Description
1	Output	0	Oscillator clock output
2	GND	Power	Power supply ground
3	DNC	DNC	Do Not Connect
4	VDD	Power	Power supply, Note 1

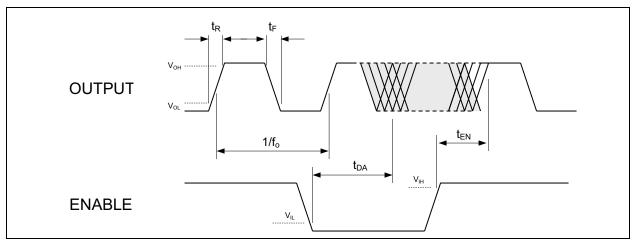
Note 1: Bypass with 0.1 μ F capacitor placed as close to V_{DD} pin as possible.

2.1 Output Buffer Options

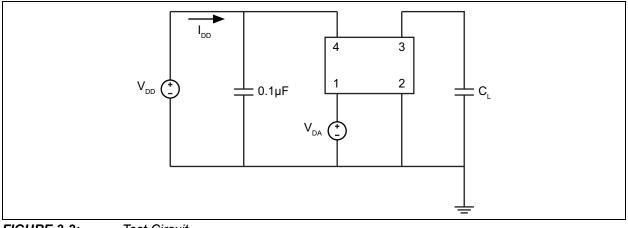
The DSC60xx family is available in multiple output driver configurations.

The low-drive DSC60x3 is configured with a low-power driver that minimizes current consumption and EMI while delivering greater than 1 mA output current at 20%/80% of the supply voltage. The standard-drive DSC60x1 delivers greater than 3 mA output current at 20%/80% of the supply voltage.

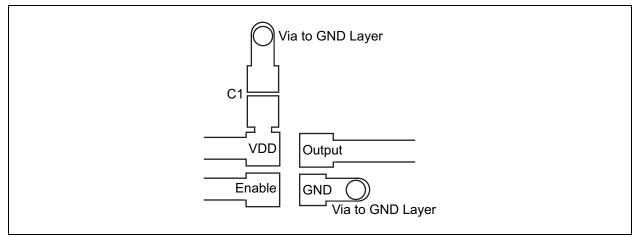
3.0 DIAGRAMS







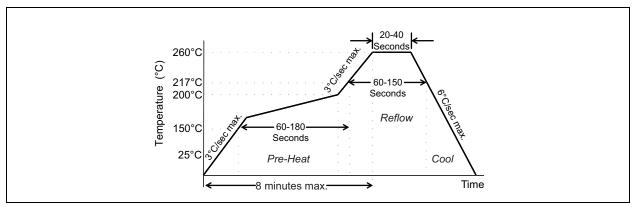


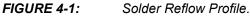




Recommended Board Layout.

4.0 SOLDER REFLOW PROFILE

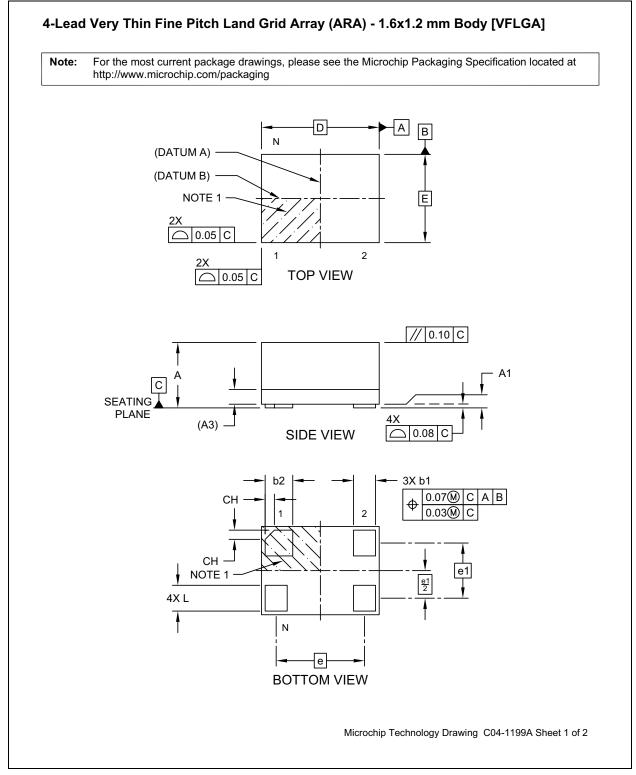




MSL 1 @ 260°C refer to JSTD-020C						
Ramp-Up Rate (200°C to Peak Temp)	3°C/sec. max.					
Preheat Time 150°C to 200°C	60 to 180 sec.					
Time maintained above 217°C	60 to 150 sec.					
Peak Temperature	255°C to 260°C					
Time within 5°C of actual Peak	20 to 40 sec.					
Ramp-Down Rate	6°C/sec. max.					
Time 25°C to Peak Temperature	8 minutes max.					

5.0 PACKAGING INFORMATION

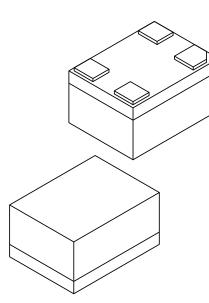
4-Lead VFLGA 1.6 mm x 1.2 mm Package Outline



4-Lead VFLGA 1.6 mm x 1.2 mm Package Outline

4-Lead Very Thin Fine Pitch Land Grid Array (ARA) - 1.6x1.2 mm Body [VFLGA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX
Number of Terminals	Ν		4	
Terminal Pitch	е		1.20 BSC	
Terminal Pitch	e1		0.75 BSC	-
Overall Height	Α	0.79	0.84	0.89
Standoff	A1	0.00	0.02	0.05
Substrate Thickness (with Terminals)	A3	3 0.20 REF		
Overall Length	D	1.60 BSC		
Overall Width	Е		1.20 BSC	_
Terminal Width	b1	0.25	0.30	0.35
Terminal Width	b2	0.325	0.375	0.425
Terminal Length	L	0.30	0.35	0.40
Terminal 1 Index Chamfer	СН	-	0.125	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

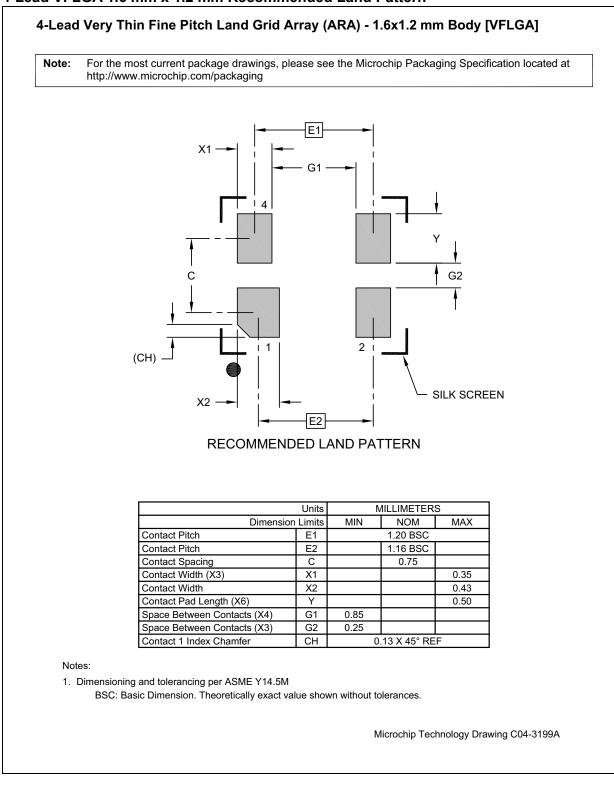
2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

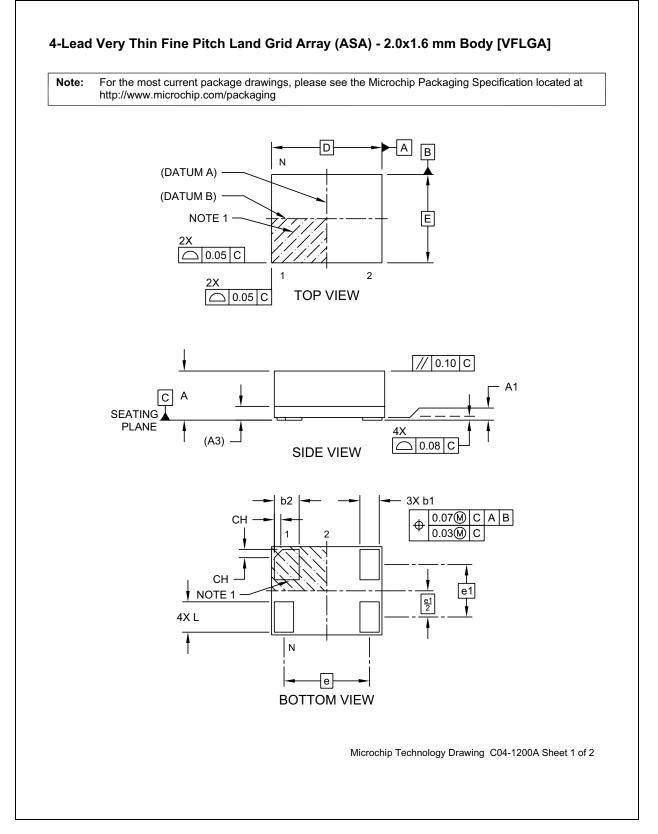
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1199A Sheet 2 of 2

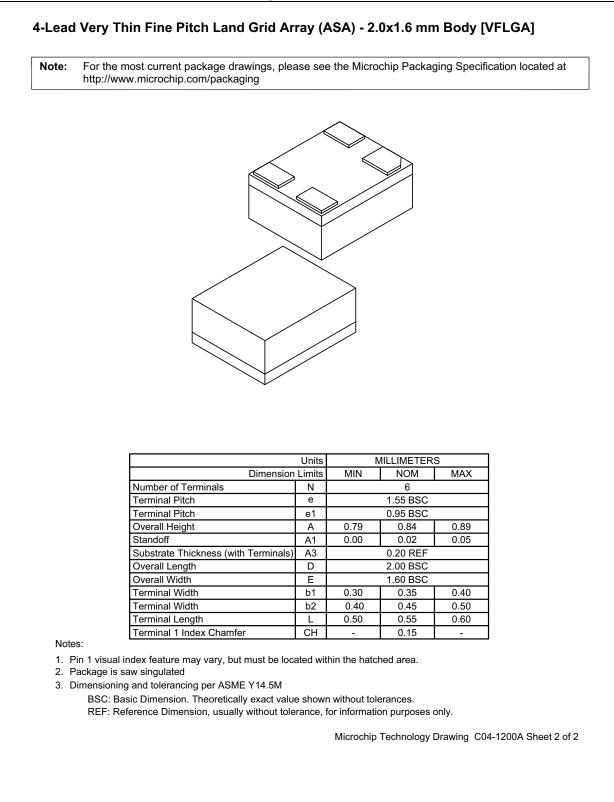
4-Lead VFLGA 1.6 mm x 1.2 mm Recommended Land Pattern



4-Lead VFLGA 2.0 mm x 1.6 mm Package Outline



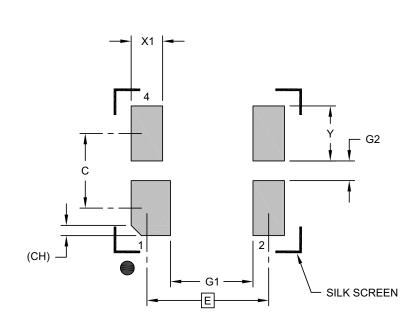
4-Lead VFLGA 2.0 mm x 1.6 mm Package Outline (Continued)



4-Lead VFLGA 2.0 mm x 1.6 mm Package Outline

4-Lead Very Thin Fine Pitch Land Grid Array (ASA) - 2.0x1.6 mm Body [VFLGA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimensior	Dimension Limits			MAX
Contact Pitch	E		1.55 BSC	
Contact Spacing	С		0.95	
Contact Width (X4)	X1			0.50
Contact Width (X2) X2				0.40
Contact Pad Length (X6)	Y	0.7		
Space Between Contacts (X4)	G1	1.05		
Space Between Contacts (X3) G2		0.25		
Contact 1 Index Chamfer	СН	0.13 X 45° REF		

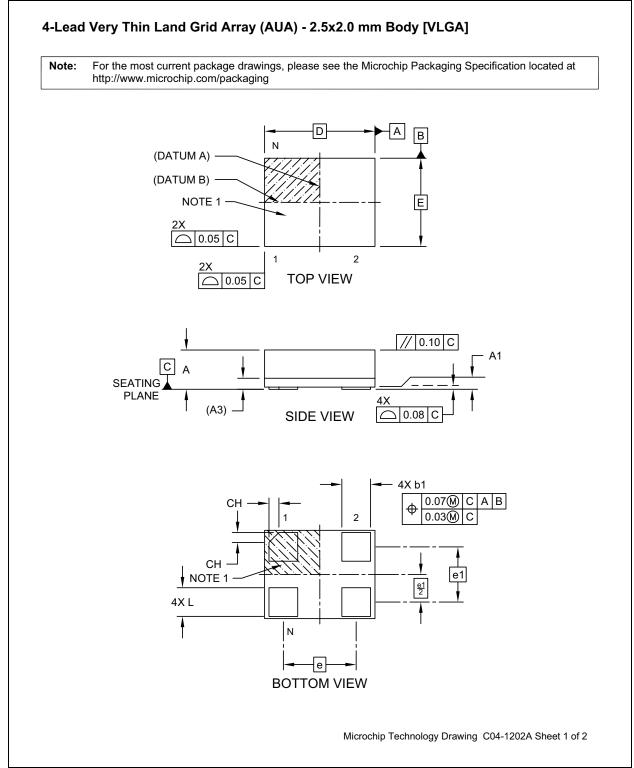
Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

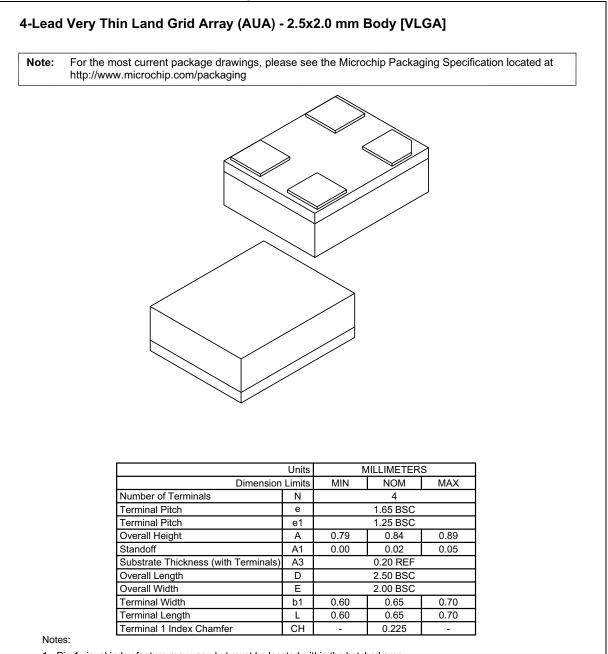
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-3200A

4-Lead VLGA 2.5 mm x 2.0 mm Package Outline



4-Lead VLGA 2.5 mm x 2.0 mm Package Outline (Continued)



1. Pin 1 visual index feature may vary, but must be located within the hatched area.

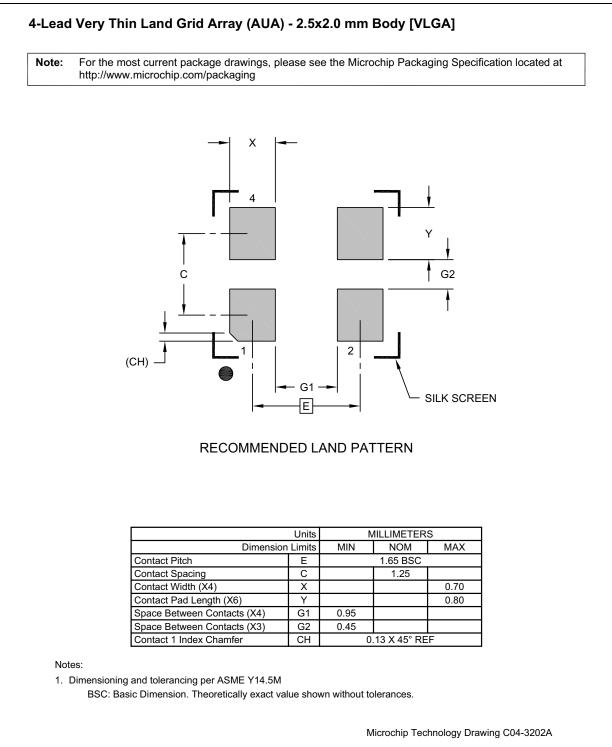
2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

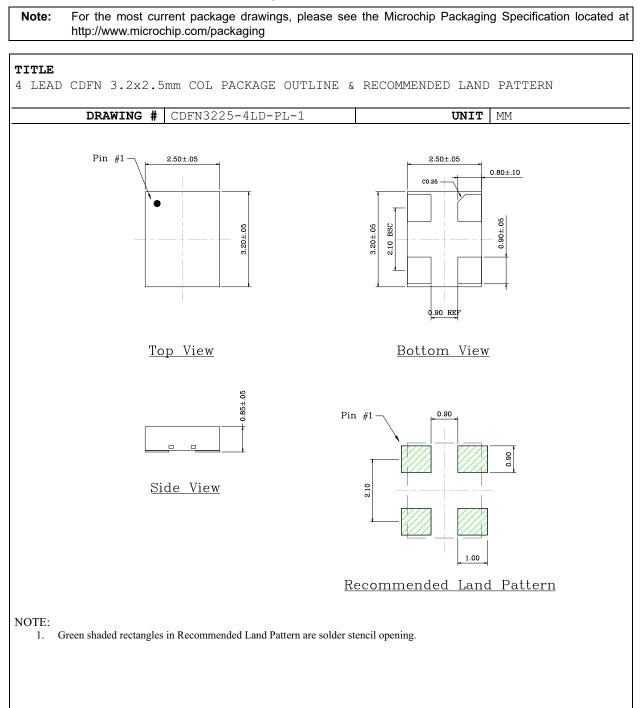
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1202A Sheet 2 of 2

4-Lead VLGA 2.5 mm x 2.0 mm Recommended Land Pattern



4-Lead CDFN 3.2 mm x 2.5 mm Package Outline and Recommended Land Pattern



APPENDIX A: REVISION HISTORY

Revision A (September 2016)

Initial creation of DSC60xx Microchip data sheet DS20005625A.

Revision B (September 2017)

- Added Power Supply Ramp value in Electrical Characteristics table.
- Redrew diagrams for clarity. No technical content affected.

Revision C (November 2018)

• Added a new condition to the Active Supply Current parameter with a new typical value in the Electrical Characteristics table.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

					Exampl	es:	
Definition D	XX Utput Package Drive rength	X Temperature Range	X X – Frequency Revision Stability	XXX.XXXX X n Frequency Tape and Reel	Últra with 2.5 n	013JI2A-100.0000: –Low Power MEMS Oscillator, Pin1 = Standby Internal Pull-Up, Low Drive Strength, 4-Lead nm x 2.0 mm VLGA, Industrial Temperature, opm Stability, Revision A, 100 MHz Frequency,	
Device:	DSC60xx:	Ultra-Lov	v Power MEMS Osc	illator	100/	0	
Pin Definition:	Selection 0 1 2 4	Pin 1Internal Pull-Up RegisterOEPull-upSTDBYPull-upFSPull-upOENoneSTDBYNoneFSNoneKHz OutputNone		egister	 b) DSC6001HE1A-016.0000T: Ultra–Low Power MEMS Oscillator, Pin1 = OE with Internal Pull–Up, Standard Drive Strength, 4-Lead 1.6 mm x 1.2 mm VFLGA, Extended Commercial Temp., ±50 ppm Stability, Revision A, 16 MHz Frequency, 1,000/Reel c) DSC6021MI2A-005Q: Ultra–Low Power MEMS Oscillator, Pin1 = Freq. Selec with Internal Pull-Up, Standard Drive Strength, 4-Lead 2.0 mm x 1.6 mm VFLGA, Industrial Temperature, ±25 ppm Stability, Revision A, Two Frequencies Configured through ClockWorks, 100/Bag 		
	5 6 8						
Output Drive Strength:	1 3	Standard Low			Note 1:	Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check	
Packages:	C = J = M = H =	4-Lead 3.2 mm x 2.5 mm DFN with your Microchip Sales Of 4-Lead 2.5 mm x 2.0 mm VLGA availability with the Tape and 4-Lead 2.0 mm x 1.6 mm VFLGA availability with the Tape and				with your Microchip Sales Office for package availability with the Tape and Reel option.	
Temperature Range:	E = I =		70°C (Extended Cor ·85°C (Industrial)	mmercial)			
Frequency Stability:	1 = 2 =	± 50 ppm ± 25 ppm					
Revision:	A =	Revision A					
Frequency:	xxxkxxx =	001.0000 I User-Define and 999.99 Frequency of	configuration code w the part online throu	Hz en 002.000 kHz /hen pin 1 = FS.			
Tape and Reel:	<blank>= T =</blank>	100/Bag 1,000/Reel					

Note 1: Please visit Microchip ClockWorks[®] Configurator Website to configure the part number for customized frequency. http://clockworks.microchip.com/timing/.

NOTES:

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